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ELECTRONICS

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Jameco Part Number 1301841





【4. 性能 PERFORMANCE】

4-1. 電気的性能 Electrical Performance

項目 Item	条件 Test Condition	規格 Requirement
4-1-1 接触抵抗 Contact Resistance	適合FPC/FFCを嵌合させ、開放電圧 20mV 以下、 短絡電流 10mA にて測定する。 (JIS C5402 5.4) Mate applicable FPC/FFC and measure by dry circuit , 20mV MAXIMUM, 10mA . (JIS C5402 5.4)	30 milliohms MAXIMUM
4-1-2 絶縁抵抗 Insulation Resistance	適合FPC/FFCを嵌合させ、隣接するターミナル間 及びターミナル、アース間に、DC 500Vを印加し 測定する。 (JIS C5402 5.2/MIL-STD-202 試験法 302) Mate applicable FPC/FFC and apply 500V DC between adjacent terminal and ground. (JIS C5402 5.2/MIL-STD-202 Method 302)	100 Megohms MINIMUM
4-1-3 耐電圧 Dielectric Strength	適合FPC/FFCを嵌合させ、隣接するターミナル間及 びターミナル、アース間に、AC 500V (実効値) を 1分間印加する。 (JIS C5402 5.1/MIL-STD-202 試験法 301) Mate applicable FPC/FFC and apply 500V AC(rms) for 1 minute between adjacent terminal or ground. (JIS C5402 5.1/MIL-STD-202 Method 301)	異常なきこと No Breakdown

4-2. 機械的性能 Mechanical Performance

項目 Item	条件 Test Condition	規格 Requirement
4-2-1 挿入力及び抜去力 Insertion / Withdrawal Force	適合FFCを用いて、毎分25±3mmの速さで挿入、 抜去を行う。 Insert and withdraw the applicable FFC to the connector at the speed rate of 25±3 mm per minute.	第6項参照 Refer to paragraph 6
4-2-2 ターミナル保持力 Terminal / Housing Retention Force	ターミナルを毎分25±3 mmの速さで引っ張る。 Apply axial pull out force at the speed rate of 25±3 mm per minute on the terminal assembled in the housing.	5.9N {0.6kgf} MINIMUM

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4-3. その他 Environmental Performance and Others

項目 Item		条件 Test Condition	規格 Requirement	
4-3-1	繰り返し挿抜 Repeated Insertion / Withdrawal	1分間に10回以下の速さで挿入、抜去を10回繰り返す。 When mated up to 10 cycles repeatedly by the rate of 10 cycles per minute.	接触抵抗 Contact Resistance	50 milliohms MAXIMUM
4-3-2	温度上昇 Temperature Rise	適合FPC/FFCを嵌合させ、最大許容総電流を通電し、コネクタの温度上昇分を測定する。 (UL 498) Mate connectors and measure the temperature rise of contact when the maximum AC rated current is passed. (UL 498)	温度上昇 Temperature Rise	30 °C MAXIMUM
4-3-3	耐振動性 Vibration	DC 1mA 通電状態にて、嵌合軸を含む互いに垂直な3方向に掃引割合 10~55~10 Hz/分、全振幅 1.5mm の振動を各 2時間 加える。 (MIL-STD-202試験法 201) Mate connectors and subject to the following vibration conditions, for a period of 2 hours in each of 3 mutually perpendicular axes, passing DC 1 mA during the test. Amplitude : 1.5 mm P-P Frequency : 10-55-10 Hz shall be traversed in 1 minute. (MIL-STD-202, Method 201)	外観 Appearance	異状なきこと No Damage
			接触抵抗 Contact Resistance	50 milliohms MAXIMUM
			瞬断 Discontinuity	1.0 microsecond MAXIMUM
4-3-4	耐衝撃性 Shock	DC 1mA 通電状態にて、嵌合軸を含む互いに垂直な 6方向に 490m/s <sup>2</sup> {50G} の衝撃を各3回加える。 (JIS C0041 / MIL-STD-202試験法 213) Mate connectors and subject to the following shock conditions. 3 times of shocks shall be applied for each 6 directions along 3 mutually perpendicular axes, passing DC 1 mA current during the test.(Total of 18 shocks) Peak value : 490 m/s <sup>2</sup> (50 G) (JIS C0041/MIL-STD-202 Method 213)	外観 Appearance	異状なきこと No Damage
			接触抵抗 Contact Resistance	50 milliohms MAXIMUM
			瞬断 Discontinuity	1.0 microsecond MAXIMUM

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項目 Item		条件 Test Condition	規格 Requirement	
4-3-5	耐熱性 Heat Resistance	適合FPC/FFCを嵌合させ、85±2°Cの雰囲気中に96時間放置後取り出し、1~2時間室温に放置する。 ( JIS C0021/MIL-STD-202 試験法 108 ) Mate FPC/FFC and expose to 85±2°C for 96 hours. Upon completion of the exposure period, the test specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed. ( JIS C0021/MIL-STD-202 Method 108)	外観 Appearance	異常なきこと No Damage
			接触抵抗 Contact Resistance	50 milliohms MAXIMUM
4-3-6	耐寒性 Cold Resistance	適合FPC/FFCを嵌合させ、-40±2°Cの雰囲気中に96時間放置後取り出し、1~2時間室温に放置する。 (JIS C0020) Mate FPC/FFC and expose to -40±2°C for 96 hours. Upon completion of the exposure period, the test specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed. (JIS C0020)	外観 Appearance	異常なきこと No Damage
			接触抵抗 Contact Resistance	50 milliohms MAXIMUM
4-3-7	耐湿性 Humidity	適合FPC/FFCを嵌合させ、40±2°C 相対湿度 90~95%の雰囲気中に96時間放置後取り出し、30分以内に測定。水滴は拭き取る。 (JIS C0022/MIL-STD-202 試験方法103) Mate FPC/FFC and expose to 40±2°C, relative humidity 90 to 95% for 96 hours. Upon completion of the exposure period, within 30 minutes which the specified measurements shall be performed. ( JIS C0022/MIL-STD-202 Method 103 )	外観 Appearance	異常なきこと No Damage
			接触抵抗 Contact Resistance	50 milliohms MAXIMUM
			耐電圧 Dielectric Strength	4-1-3項 満足の こと Must meet 4-1-3
			絶縁抵抗 Insulation Resistance	50 Megohms MINIMUM

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項目 Item		条件 Test Condition	規格 Requirement	
4-3-8	温度サイクル Temperature Cycling	適合FPC/FFCを嵌合させ、-55±3℃に30分、+85±2℃に30分、これを1サイクルとし、5サイクル繰り返す。但し、温度移行時間は3分以内とする。試験後1~2時間室温に放置する。(JIS C0025) Mate connectors and subject to the following conditions for 5 cycles. Upon completion of the exposure period, the test specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed. 1 cycle a) -55±3℃ 30minutes b) +85±2℃ 30minutes (Transit time shall be with in 3 minutes) (JIS C0025)	外 観 Appearance	異状なきこと No Damage
			接触抵抗 Contact Resistance	50 milliohms MAXIMUM
4-3-9	塩水噴霧 Salt Spray	適合FPC/FFCを嵌合させ、35±2℃にて重量比 5±1%の塩水を48±4時間噴霧し、試験後常温で水洗いした後、室温で乾燥させる。(JIS C0023/MIL-STD-202 試験方法101) Mate connectors and expose to the following salt mist condition. Upon completion of the exposure period, salt deposits shall be removed by a gentle wash or dip in running water, after which the specified measurements shall be performed. NaCl solution Concentration : 5±1% Spray time : 48±4 hours Ambient temperature : 35±2℃ (JIS C0023/MIL-STD-202 Method 101)	外 観 Appearance	異状なきこと No Damage
			接触抵抗 Contact Resistance	50 milliohms MAXIMUM
4-3-10	亜硫酸ガス SO <sub>2</sub> Gas	適合FPC/FFCを嵌合させ、40±2℃にて50±5ppmの亜硫酸ガス中に24時間放置する。 Mate FPC/FFC and expose them to the following SO <sub>2</sub> gas atmosphere. Temperature 40±2℃ Gas Density 50±5ppm Duration 24 hours	接触抵抗 Contact Resistance	50 milliohms MAXIMUM
4-3-11	耐アンモニア性 NH <sub>3</sub> Gas	適合FPC/FFCを嵌合させ、濃度28%のアンモニア水を入れた容器中に40分間放置する。(1Lに対して25mLの割合) Mate FPC/FFC and 40 minutes exposure to NH <sub>3</sub> gas evaporating from 28% Ammonia solution.	外 観 Appearance	異状なきこと No Damage
			接触抵抗 Contact Resistance	50 milliohms MAXIMUM

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項目 Item		条件 Test Condition	規格 Requirement	
4-3-12	半田付け性 Solder Ability	端子先端より1.5mm迄、245±5℃の半田に3±0.5秒浸す。 Tip of solder tails into the molten solder (held at 245±5℃) up to 1.5mm from the bottom of the housing for 3±0.5 seconds.	濡れ性 Solder Wetting	浸漬面積の75%以上 75% of immersed area must show no voids, pin holes.
4-3-13	半田耐熱性 Resistance to Soldering Heat	(リフロー時) <u>When reflowing</u> 第7項の条件にて、2回リフローを行う。 Refer to paragraph 7, two times.	外観 Appearance	端子ガタ、割れ等 異状無き事 No Damage
		(手半田) <u>Soldering iron method</u> 端子先端より1.5mm迄、370~400℃の半田ゴテにて、最大5秒加熱する。 1.5mm from terminal tip. Soldering time : 5 seconds MAX. Solder temperature : 370~400℃		

( ) : 参考規格  
Reference Standard

【5. 外観形状、寸法及び材質 PRODUCT SHAPE, DIMENSIONS AND MATERIALS】

図面参照 Refer to the drawing.

【6. 挿抜力及び抜去力 INSERTION / WITHDRAWAL FORCE】

下記のFFCを使用した場合 (参考) In case of used the following FFC (Reference)  
厚さ : 0.3mm Thickness : 0.3mm

極数 Number of Circuit	単位 UNIT	挿入力 (最大値) Insertion Force (MAXIMUM)			抜去力 (最小値) Withdrawal Force (MINIMUM)		
		初回 1st	6回目 6th	10回目 10th	初回 1st	6回目 6th	10回目 10th
4	N (kgf)	11.2 (1.15)	14.2 (1.45)	14.2 (1.45)	0.4 (0.04)	0.3 (0.03)	0.3 (0.03)
5	N (kgf)	12.7 (1.3)	15.6 (1.6)	15.6 (1.6)	0.5 (0.05)	0.4 (0.04)	0.4 (0.04)

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極数 Number of Circuit	単位 UNIT	挿入力 (最大値) Insertion Force (MAXIMUM)			抜去力 (最小値) Withdrawal Force (MINIMUM)		
		初回 1st	6回目 6th	10回目 10th	初回 1st	6回目 6th	10回目 10th
6	N (kgf)	14.2 (1.45)	17.1 (1.75)	17.1 (1.75)	0.6 (0.06)	0.5 (0.05)	0.5 (0.05)
7	N (kgf)	15.6 (1.6)	18.6 (1.9)	18.6 (1.9)	0.7 (0.07)	0.6 (0.06)	0.6 (0.06)
8	N (kgf)	17.1 (1.75)	20.0 (2.05)	20.0 (2.05)	0.8 (0.08)	0.7 (0.07)	0.7 (0.07)
9	N (kgf)	18.6 (1.9)	21.5 (2.2)	21.5 (2.2)	0.9 (0.09)	0.8 (0.08)	0.8 (0.08)
10	N (kgf)	20.0 (2.05)	23.0 (2.35)	23.0 (2.35)	1.0 (0.1)	0.9 (0.09)	0.9 (0.09)
11	N (kgf)	21.5 (2.2)	24.5 (2.5)	24.5 (2.5)	1.1 (0.11)	1.0 (0.1)	1.0 (0.1)
12	N (kgf)	23.0 (2.35)	25.9 (2.65)	25.9 (2.65)	1.2 (0.12)	1.1 (0.11)	1.1 (0.11)
13	N (kgf)	24.5 (2.5)	27.4 (2.8)	27.4 (2.8)	1.3 (0.13)	1.2 (0.12)	1.2 (0.12)
14	N (kgf)	25.9 (2.65)	28.9 (2.95)	28.9 (2.95)	1.4 (0.14)	1.3 (0.13)	1.3 (0.13)
15	N (kgf)	27.4 (2.8)	30.3 (3.1)	30.3 (3.1)	1.5 (0.15)	1.4 (0.14)	1.4 (0.14)
16	N (kgf)	28.9 (2.95)	31.8 (3.25)	31.8 (3.25)	1.6 (0.16)	1.5 (0.15)	1.5 (0.15)
17	N (kgf)	30.3 (3.1)	33.3 (3.4)	33.3 (3.4)	1.7 (0.17)	1.6 (0.16)	1.6 (0.16)
18	N (kgf)	31.8 (3.25)	34.7 (3.55)	34.7 (3.55)	1.8 (0.18)	1.7 (0.17)	1.7 (0.17)
19	N (kgf)	33.3 (3.4)	36.2 (3.7)	36.2 (3.7)	1.9 (0.19)	1.8 (0.18)	1.8 (0.18)
20	N (kgf)	34.7 (3.55)	37.7 (3.85)	37.7 (3.85)	2.0 (0.2)	1.9 (0.19)	1.9 (0.19)
21	N (kgf)	36.2 (3.7)	39.2 (4.0)	39.2 (4.0)	2.1 (0.21)	2.0 (0.2)	2.0 (0.2)
22	N (kgf)	37.7 (3.85)	40.6 (4.15)	40.6 (4.15)	2.2 (0.22)	2.1 (0.21)	2.1 (0.21)
23	N (kgf)	39.2 (4.0)	42.1 (4.3)	42.1 (4.3)	2.3 (0.23)	2.2 (0.22)	2.2 (0.22)
24	N (kgf)	40.6 (4.15)	43.6 (4.45)	43.6 (4.45)	2.4 (0.24)	2.3 (0.23)	2.3 (0.23)
25	N (kgf)	42.1 (4.3)	45.0 (4.6)	45.0 (4.6)	2.5 (0.25)	2.4 (0.24)	2.4 (0.24)
26	N (kgf)	43.6 (4.45)	46.5 (4.75)	46.5 (4.75)	2.6 (0.26)	2.5 (0.25)	2.5 (0.25)
27	N (kgf)	45.0 (4.6)	48.0 (4.9)	48.0 (4.9)	2.7 (0.27)	2.6 (0.26)	2.6 (0.26)

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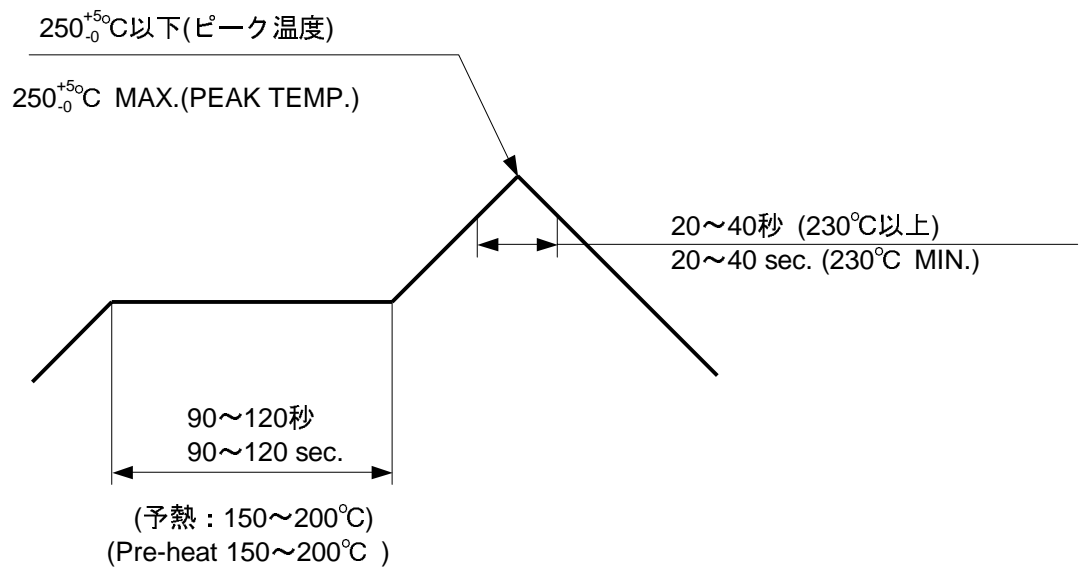
EN-37-1(019)





極数 Number of Circuit	単位 UNIT	挿入力 (最大値) Insertion Force (MAXIMUM)			抜去力 (最小値) Withdrawal Force (MINIMUM)		
		初回 1st	6回目 6th	10回目 10th	初回 1st	6回目 6th	10回目 10 <sup>th</sup>
28	N (kgf)	46.5 (4.75)	49.4 (5.05)	49.4 (5.05)	2.8 (0.28)	2.7 (0.27)	2.7 (0.27)
29	N (kgf)	48.0 (4.9)	50.9 (5.2)	50.9 (5.2)	2.9 (0.29)	2.8 (0.28)	2.8 (0.28)
30	N (kgf)	49.4 (5.05)	52.4 (5.35)	52.4 (5.35)	3.0 (0.3)	2.9 (0.29)	2.9 (0.29)

【7. 赤外線リフロー条件 INFRARED REFLOW CONDITION】



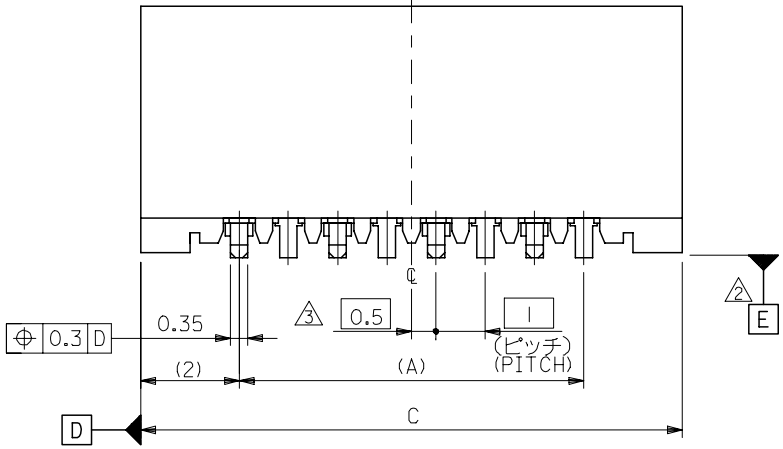
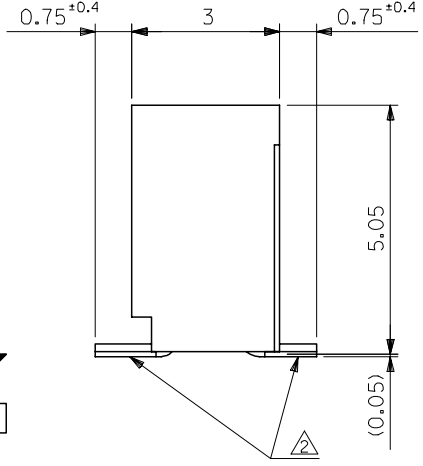
**温度条件グラフ**  
(温度は基板パターン面)  
**TEMPERATURE CONDITION GRAPH**  
(TEMPERATURE ON BOARD PATTERN SIDE)

注記 : 本リフロー条件に関しては、リフロー装置及び基板などにより条件が異なりますので、事前にリフロー評価の確認をお願いします。  
NOTE : Please check the reflow soldering condition by your own devices beforehand. Because the condition changes by the soldering devisces, p.c.boards, and so on.

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33	31.05	29	52808-3019	30
32	30.05	28	-2919	29
31	29.05	27	-2819	28
30	28.05	26	-2719	27
29	27.05	25	-2619	26
28	26.05	24	-2519	25
27	25.05	23	-2419	24
26	24.05	22	-2319	23
25	23.05	21	-2219	22
24	22.05	20	-2119	21
23	21.05	19	-2019	20
22	20.05	18	-1919	19
21	19.05	17	-1819	18
20	18.05	16	-1719	17
19	17.05	15	-1619	16
18	16.05	14	-1519	15
17	15.05	13	-1419	14
16	14.05	12	-1319	13
15	13.05	11	-1219	12
14	12.05	10	-1119	11
13	11.05	9	-1019	10
12	10.05	8	-0919	9
11	9.05	7	-0819	8
10	8.05	6	-0719	7
9	7.05	5	-0619	6
8	6.05	4	-0519	5
7	5.05	3	52808-0419	4

注記 NOTES:

1. 使用材料 MATERIAL  
 ハウジング: PPS, UL94V-0 HOUSING : PPS, UL94V-0  
 ターミナル: リン青銅 ( $\pm 0.25$ ) TERMINAL : PHOSPHOR BRONZE  
 メッキ: ニッケル下地鍍ビスマスメッキ PLATING : TIN-BISMUTH OVER NICKEL

△ 基準面 [E] からのソルダーテールの半田付け面のズレ量は、  
 上方向に0.1 MAX. 下方向0.15 MAX. とする。  
 MISALIGNMENT OF SOLDER TAIL FROM [E]  
 : UPPER DIRECTION 0.1 MAX. , LOWER DIRECTION 0.15 MAX.

△ 偶数極に適用。  
 APPLY FOR EVEN CKT.

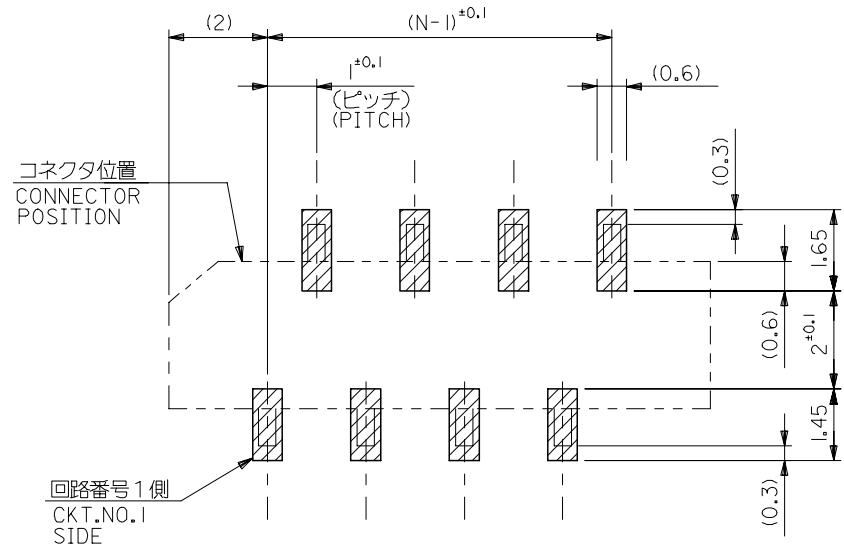
4. 本製品は52808-\*\*-10の鉛フリー品である。  
 THIS PRODUCT IS LEAD FREE OF 52808-\*\*-10

REVISED EC NO: J2006-1497 DRW: NABE1 2005/11/04 CHK: KYOYODA 2005/11/07 APP: NUKITA 2005/11/11	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		10 UNDER	±0.2	DRAWN BY M. NABE1	DATE '04/02/19	TITLE 1.0 FFC CONN. NON ZIF SMT. ST. -LEAD FREE-			
		10 OVER 30 UNDER	±0.25	CHECKED BY M. SASAO	DATE '04/02/19	MOLEX INCORPORATED			
		30 OVER	±0.3	APPROVED BY M. SASAO	DATE '04/02/19				
A	REV	ANGULAR	±3 °	MATERIAL NO. SEE CHART		DOCUMENT NO. SD-52808-027		SHEET NO. 1 OF 1	

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(仕上がり厚さ)  $0.3^{+0.03}$   
THICKNESS  
適合FPC推奨寸法  
APPLICABLE FPC  
RECOMMENDED DIMENSION.



参考基板レイアウト (マウント面)  
RECOMMENDED P.C.BOARD  
PATTERN DIMENSION. (REF.)  
(MOUNTING AREA)

FPCについて:

- 打抜き方向は、導体側から補強板側を推奨いたします。
- 補強フィルム材質は、ポリイミドを推奨いたします。
- 接着剤は、熱硬化接着剤を推奨いたします。

ABOUT FPC:

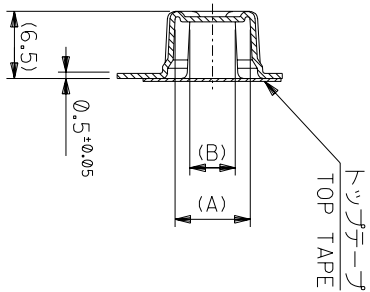
RECOMMENDED PUNCHER DIRECTION: FROM CONDUCTOR SIDE TO STIFFENER BOARD SIDE.

RECOMMENDED MATERIAL:

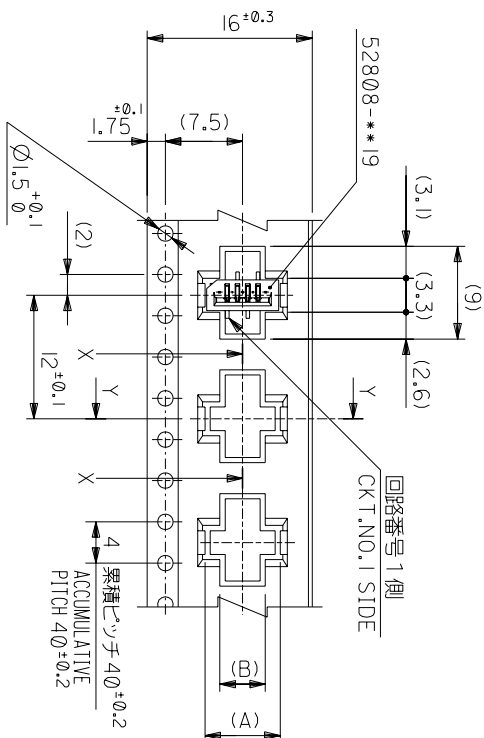
STIFFENER FILM: POLYIMIDE  
BONDING AGENT: THERMOSETTING BONDING AGENT

REVISED EC NO: J2006-1497 DRW: NABEI 2005/11/04 CHK: KATOYODA 2005/11/07 APPR: NUKITA 2005/11/11 A	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	10 UNDER	±0.2	DRAWN BY M. NABEI	DATE '04/02/19	TITLE 1.0 FFC CONN. NON ZIF SMT. ST. -LEAD FREE-		
	10 <sup>0</sup> OVER 30 UNDER	±0.25	CHECKED BY M. SASAO	DATE '04/02/19	MOLEX INCORPORATED		
	30 OVER	±0.3	APPROVED BY M. SASAO	DATE '04/02/19	MATERIAL NO. SEE CHART	DOCUMENT NO. SD-52808-027	SHEET NO. 2 OF 2
	ANGULAR	±3 °	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3					

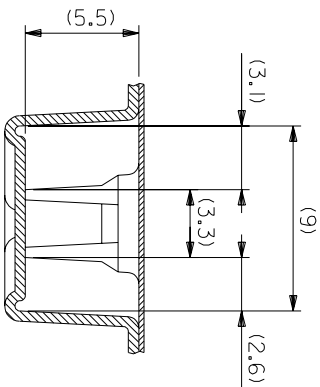




SECT:Y-Y



SECT:X-X  
(SCALE:4-1)



16mm幅キヤリヤテープ  
16mm WIDTH CARRIER TAPE

角度 ANGLE	±3°
30以上	±0.2
10以下	±0.25
10 UNDER	±0.2
30 UNDER	±0.2

記号	新規作成	02004-2528
TR	変更内容	
GENERAL	REVISION RECORD	

DR-CHK.	DATE
M.S.	M/W/02/19
MAN	

仕上げ FINISH	—#—
適用電線範囲 WIRE RANGE	—#—
標準外径 INS. RANGE	—#—
DRAWN BY	M/W/02/19
CHK'D BY	M/W/02/19
APP'D BY	M/SASAO
尺度 SCALE	—#—
DATE	M/SASAO

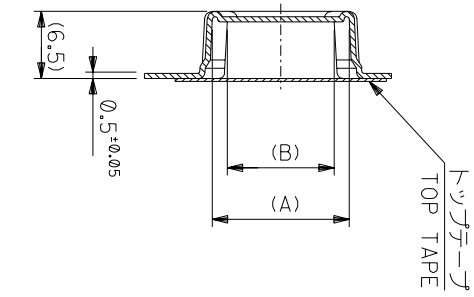
REVISE ONLY ON CAD SYSTEM	
TITLE 名称	MOLEX-JAPAN CO.,LTD.
1.0 FCC CONN NON ZIF	MOLEX 日本モリス株式会社
SMT ST Embstd PKG	
-LEAD FREE-	
DWG. NO.	SD-52808-028
(SHEET 2 OF 6)	
REV	0

MODEL NO.	52808-**-70
CARRIER TAPE WIDTH	16
C	17.5
(B)	5.4
(A)	8.3
MATERIAL NO.	52808-0470
種数	4
CKT.	5

材料 MATERIAL SHEET 1 OF 6 参照  
REFER TO SHEET 1 OF 6

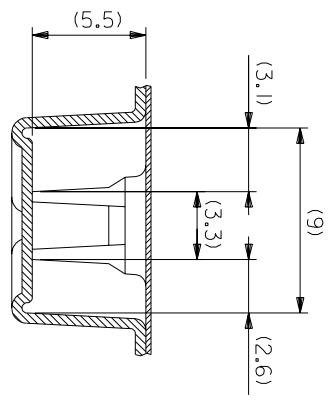
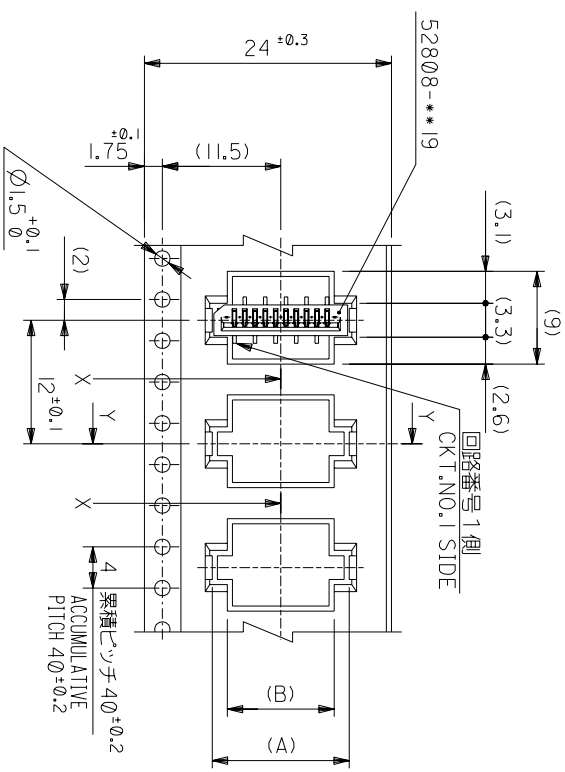
MOLEX-JAPAN CO.,LTD.  
MOLEX 日本モリス株式会社

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SECT:Y-Y

24mm幅キャリアテープ  
24mm WIDTH CARRIER TAPE



SECT:X-X  
(SCALE:4-1)

MODEL NO.	52808-**70	キャリアテープ幅 CARRIER TAPE WIDTH	C	(B)	(A)	種数 CKT.
	24	25.5	10.4	13.3	52808-1070	10
			9.4	12.3	52808-0970	9
			8.4	11.3	52808-0870	8
			7.4	10.3	52808-0770	7
			6.4	9.3	52808-0670	6

材料 MATERIAL SHEET 1 OF 6 参照 REFER TO SHEET 1 OF 6  
仕上げ FINISH #  
適用電線範囲 WIRE RANGE #  
検査外径 INS. RANGE #  
DRAWN BY 04/02/19 CHK'D BY 04/02/19  
M.NABEY M.SASAO  
APP'D BY 04/02/19 SCALE #  
M.SASAO  
MATERIAL NO. MOLEX-JAPAN CO.,LTD.  
MOLEX 日本モリス株式会社  
REVISE ONLY ON CAD SYSTEM

角度 ANGLE	±3°
30 以上	±0.2
10 以上	±0.25
10 未満	±0.2
10 未満	±0.2

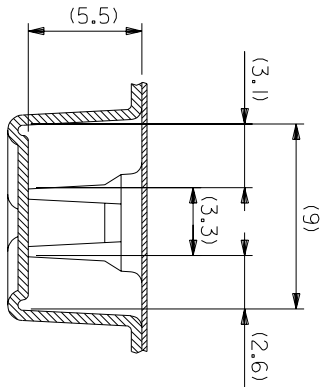
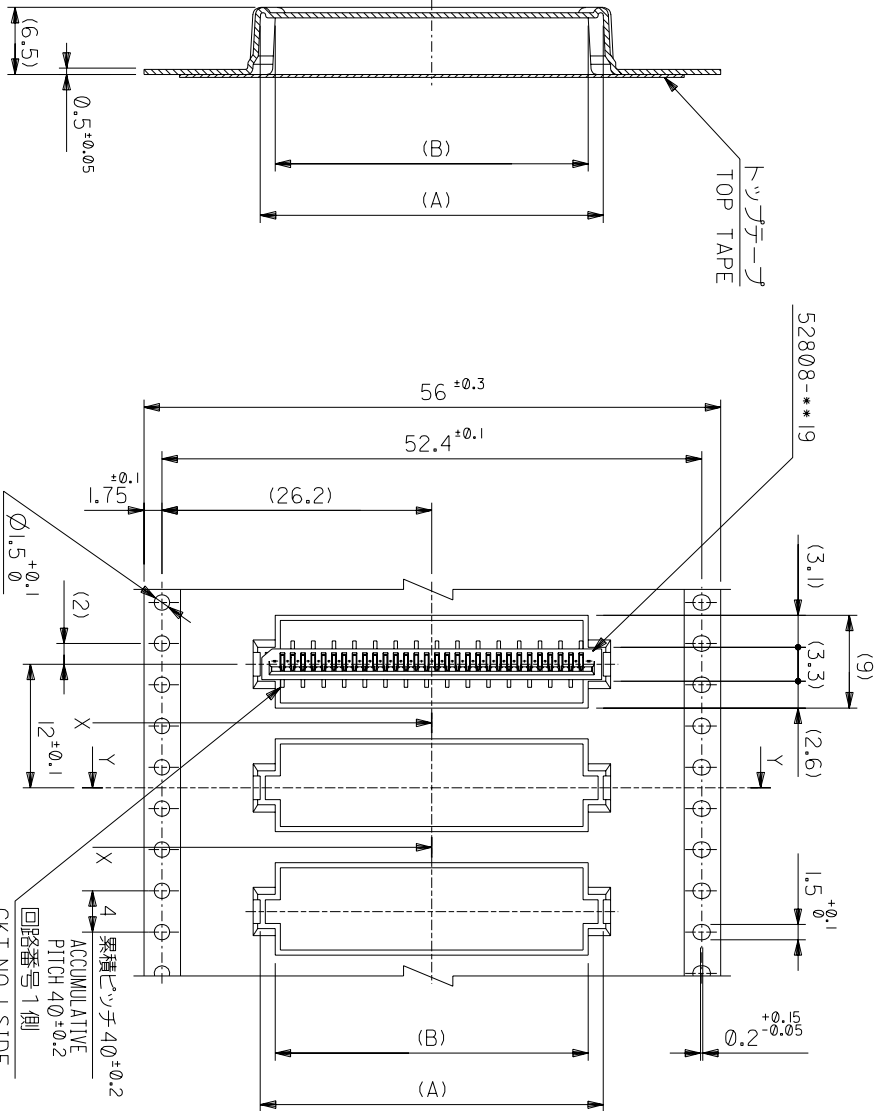
記号 LTR	0	新規作成 (12004-2528)	DR-CHK.	DATE	04/02/19
REVISION RECORD		変更内容			
GENERAL DIMENSIONS					

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SD-52808-028.S03









56mm幅キヤリヤテープ  
56mm WIDTH CARRIER TAPE

SECT:Y-Y

PULL OUT DIRECTION  
引抜き方向

累積ピッチ  $4\phi \pm 0.2$   
ACUMULATIVE PITCH  $4\phi \pm 0.2$   
回路番号 1側  
CKT.NO.1 SIDE

52808-**-70	MODEL NO.	56	57.5	30.4	29.4	33.3	32.3	52808-3070	30
56	CARRIER TAPE WIDTH	C	(B)	(A)	MATERIAL NO.	種数	種数	種数	種数

材料 MATERIAL SHEET 1 OF 6 参照 REFER TO SHEET 1 OF 6  
仕上げ FINISH  
適用電線範囲 INS. RANGE  
DRAWN BY 04/02/19 CHK'D BY 04/02/19  
M.NABEI M.SASAO  
APP'D BY 04/02/19 M.SASAO  
M.SASAO

角度 ANGLE	$\pm 3^\circ$
30以上	$\pm 0.2$
10以下	$\pm 0.15$
未測	$\pm 0.2$
10以下	$\pm 0.2$

記号	0	新規作成 (12004-2528)	DR	DATE	04/02/19
TR	0	変更内容	CHK.	DATE	04/02/19
GENERAL TOLERANCES	M.SASAO				

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